



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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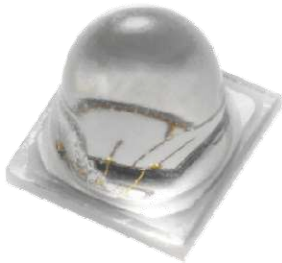
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EAUVA35353

1.8W Series



Introduction

The EAUVA35353 product series is a ceramic based LED with high quality and reliability that suitable for UV application.

Features

- ◆ High power UVA LED
- ◆ Dimension 3.5mm* 3.5mm* 3.5mm
- ◆ ESD protection up to 8KV
- ◆ RoHS compliant
- ◆ Pb free
- ◆ EU REACH compliant
- ◆ Halogen Free compliant
(Br<900ppm,Cl<900ppm,Br+Cl<1500ppm)

Applications

- ◆ UV Sterilization System
- ◆ UV Photo-catalyst
- ◆ UV Sensor Light

Product Nomenclature

EAUVA35353XXY

EA = Everlight Americas

UVA = UVA

3535 = 3.5mm x 3.5mm Package

3 = Angle: 50°

XX = Wavelength Range [1]

Y = Minimum Radiant Flux Spec [2]

Notes:

1. Wavelength Range

Symbol	Description
BC	360~370nm
EF	380~390nm
GH	390~400nm
IJ	400~410nm

2. Minimum Radiant Flux Spec

Symbol	Description
7	900mW
8	1000mW

Absolute Maximum Ratings

Parameter	Symbol	Ratings	Unit
Max. DC Forward Current (mA)	I _F	700	mA
Max. ESD Resistance	V _B	8000	V
Max. Junction Temperature	T _J	95	°C
Operating Temperature	T _{Opr}	-40 ~ +85	°C
Storage Temperature	T _{Stg}	-40 ~ +85	°C

PN of the EAUVA35353 series: UVA LEDs

UV, EAUVA35353 series LEDs at 500mA are listed below

Color	Order Code of EAUVA35353	Minimum Radiant Flux (mW)	Peak Wavelength (nm)	Forward Voltage (V)
Ultraviolet	EAUVA35353BC7	900	360~370	3.0~4.0
	EAUVA35353EF8	1000	380~390	3.0~4.0
	EAUVA35353GH8	1000	390~400	3.0~4.0
	EAUVA35353IJ8	1000	400~410	3.0~4.0

Product Binning Radiant Flux Bins

Bin Code	Minimum Radiant Flux (mW)	Maximum Radiant Flux (mW)
U1	900	1000
U2	1000	1100
U3	1100	1200
U4	1200	1300
U5	1300	1400
U6	1400	1500
U7	1500	1600

Notes:

1. Radiant flux measurement tolerance: $\pm 10\%$.
2. Forward voltage bins are defined at $I_F=500\text{mA}$ operation.

Peak Wavelength Bins

Group	Bin	Minimum Peak Wavelength (nm)	Maximum Peak Wavelength (nm)
U	36	360	370
	38	380	390
	39	390	400
	40	400	410

Notes:

1. Peak Wavelength measurement tolerance: $\pm 1\text{nm}$.
2. Forward voltage bins are defined at $I_F=500\text{mA}$ operation.

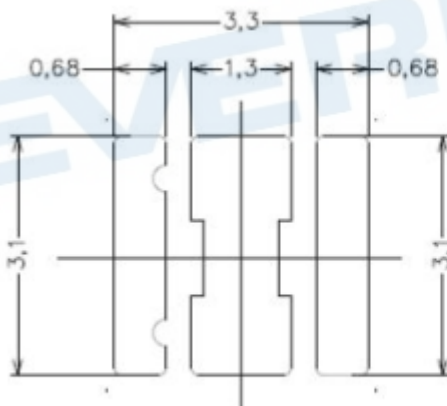
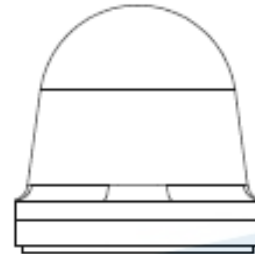
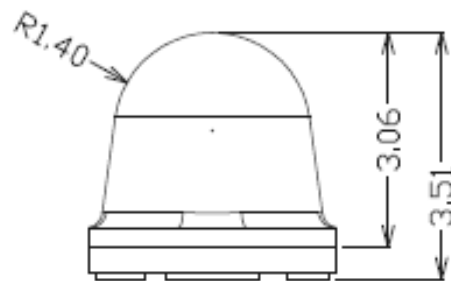
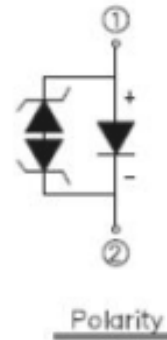
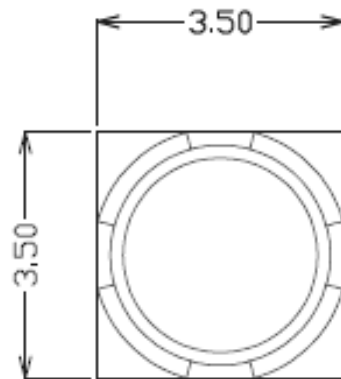
Forward Voltage Bins

Bin	Minimum Forward Voltage (V)	Maximum Forward Voltage (V)
3032	3.0	3.2
3234	3.2	3.4
3436	3.4	3.6
3638	3.6	3.8
3840	3.8	4.0

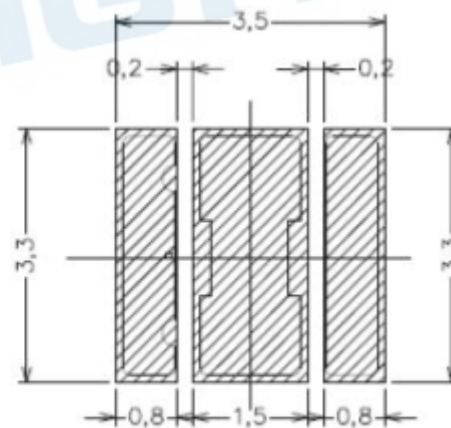
Notes:

1. Forward voltage measurement tolerance: $\pm 2\%$.
2. Forward voltage bins are defined at $I_F=500\text{mA}$ operation.

Mechanical Dimension



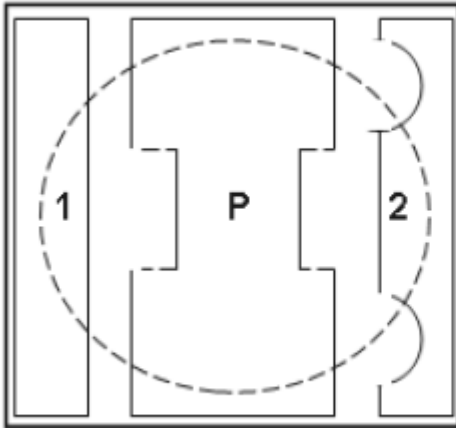
Solder pad design



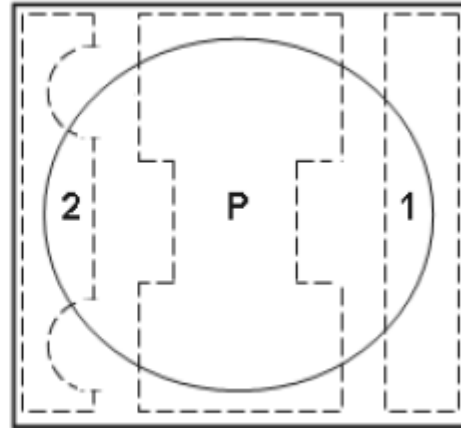
Soldering patterns

1. Dimensions are in millimeters.
2. Tolerances unless mentioned are ± 0.1 mm

Pad Configuration



BOTTOM VIEW



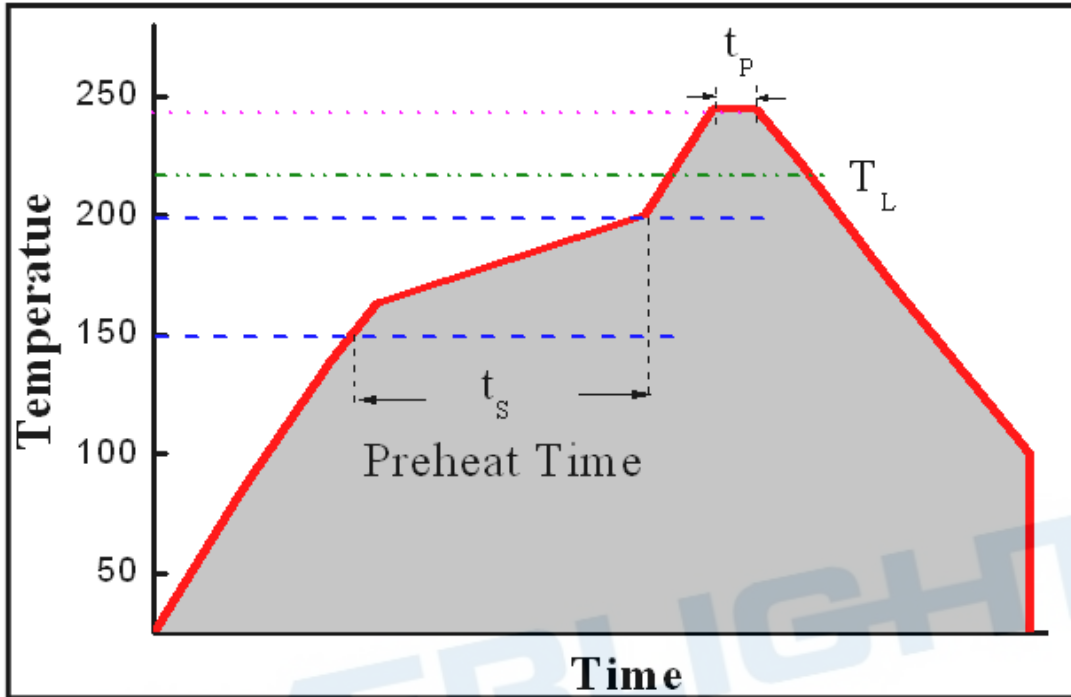
TOP VIEW

PAD	FUNCTION
1	ANODE
2	CATHODE
P	THERMAL PAD

Reflow Soldering Characteristics

For Reflow Process

- a. ELUA series are suitable for SMT processes.
- b. Curing of glue in oven must be according to standard operation flow processes.

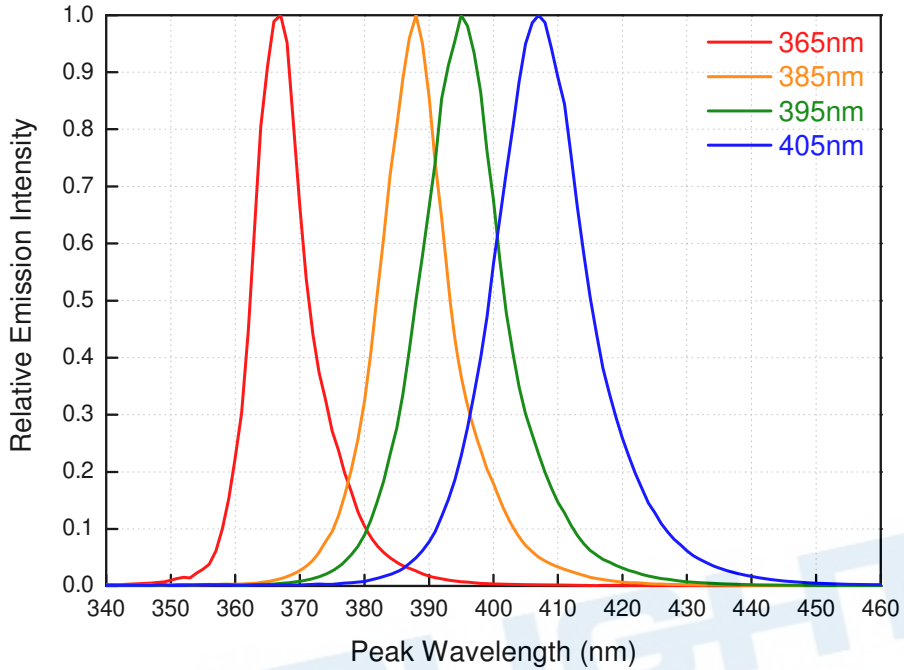


Profile Feature	Lead Free Assembly
Ramp-Up Rate	2-3 °C/S
Preheat Temperature	150-200 °C
Preheat Time (t_s)	60-120 S
Liquid Temperature (T_L)	217 °C
Time maintained above T_L	60-90 S
Peak Temperature (T_p)	240±5 °C
Peak Time (t_p)	Max 20 S
Ramp-Down Rate	3-5 °C/S

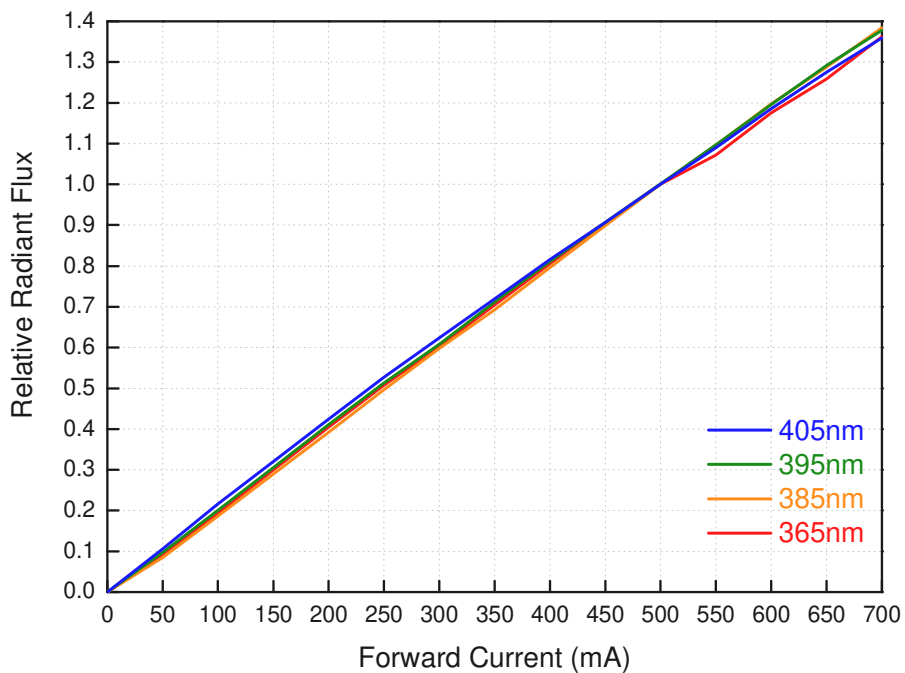
- c. Reflow soldering should not be done more than twice.
- d. In soldering process, stress on the LEDs during heating should be avoided.
- e. After soldering, do not bend the circuit board.

Typical Characteristics Curves

Spectrum @ Thermal Pad Temperature = 25°C

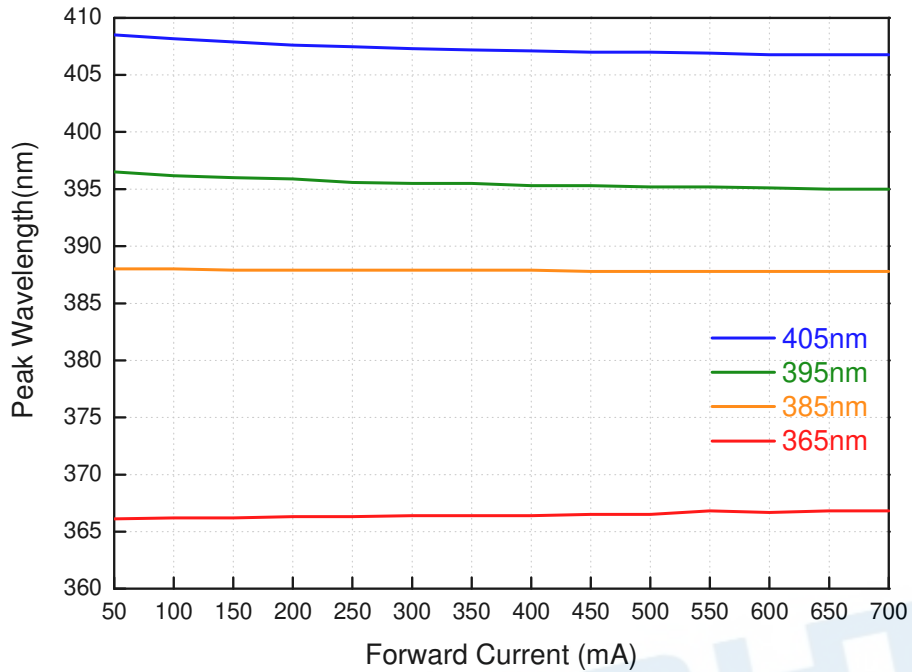


Relative Radiant Flux vs. Forward Current
@ Thermal Pad Temperature = 25°C



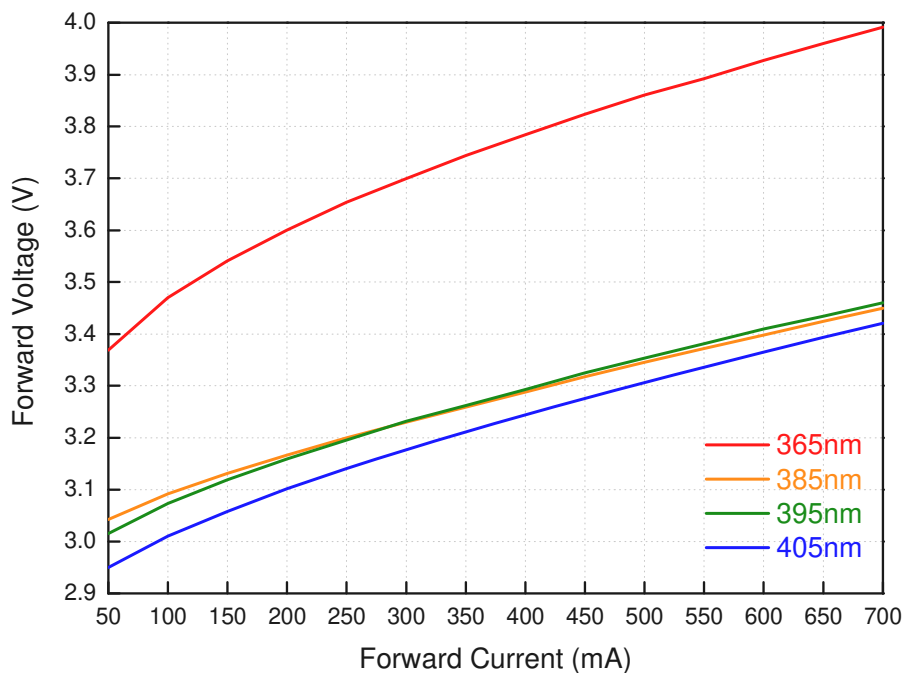
Peak Wavelength vs. Forward Current

@ Thermal Pad Temperature = 25°C

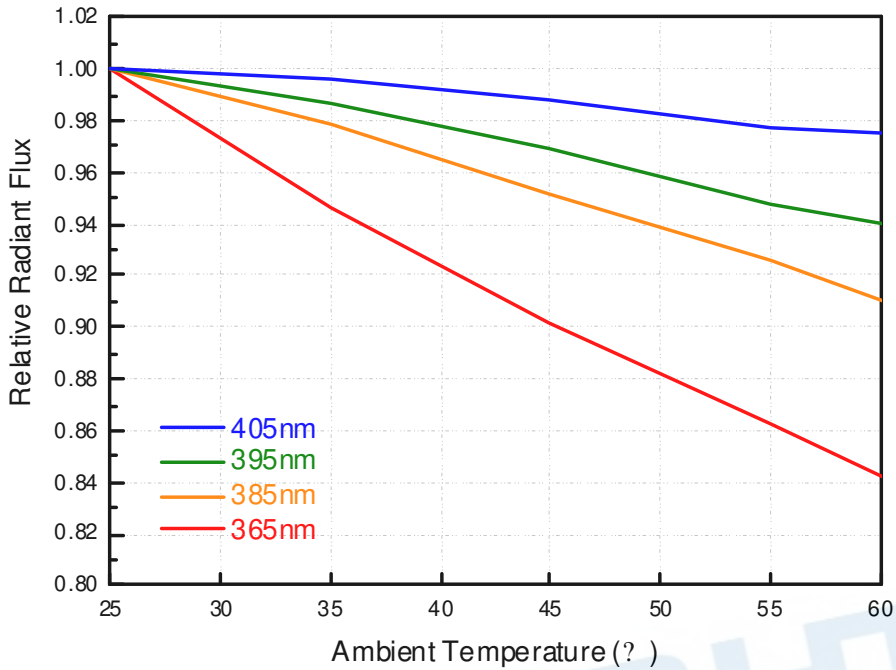


Forward Voltage vs. Forward Current

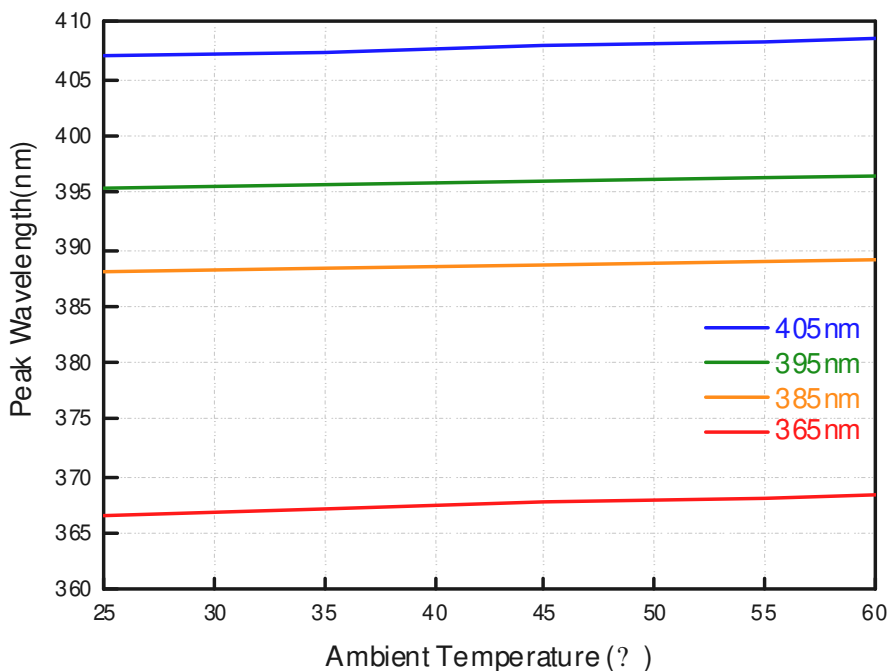
@ Thermal Pad Temperature = 25°C



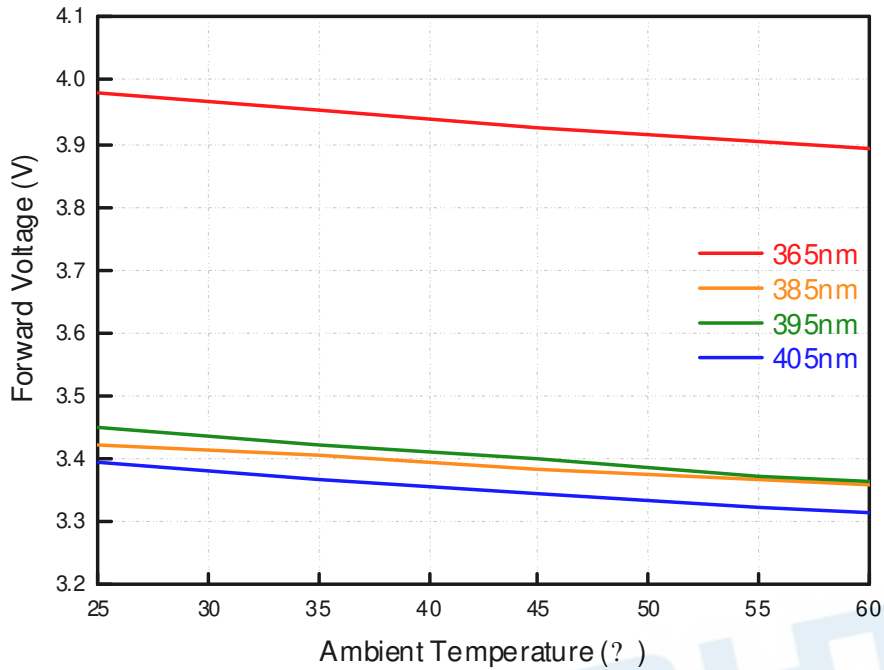
Relative Radiant Flux vs. Ambient Temperature @ Forward Current = 500mA



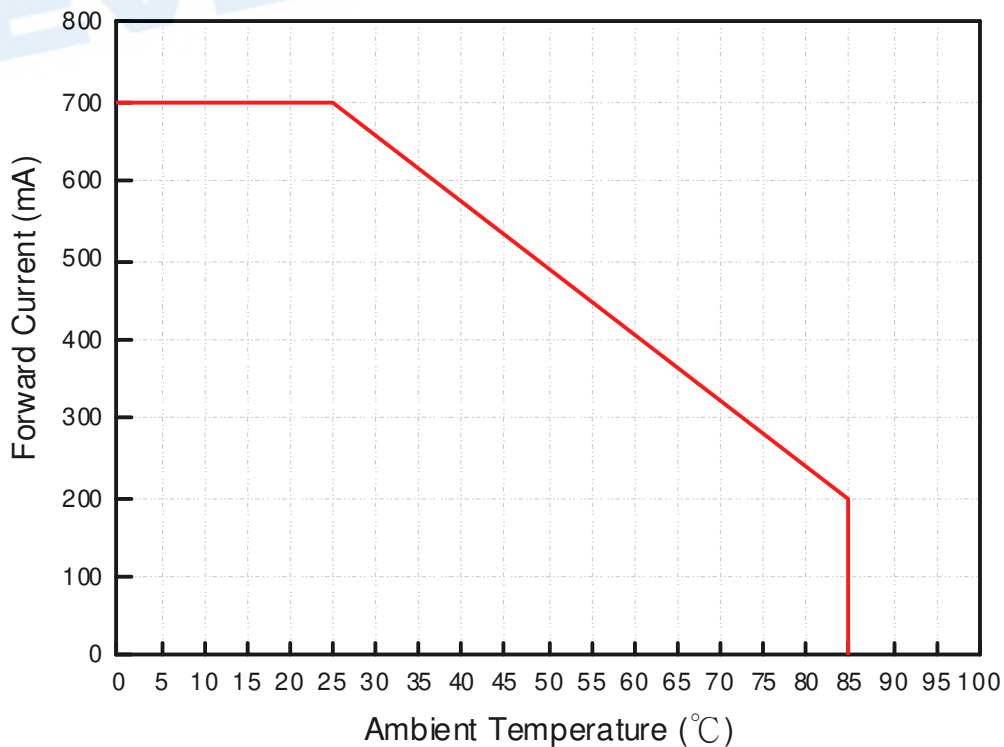
Peak Wavelength vs. Ambient Temperature @ Forward Current = 500mA



Forward Voltage vs. Ambient Temperature @ Forward Current = 500mA

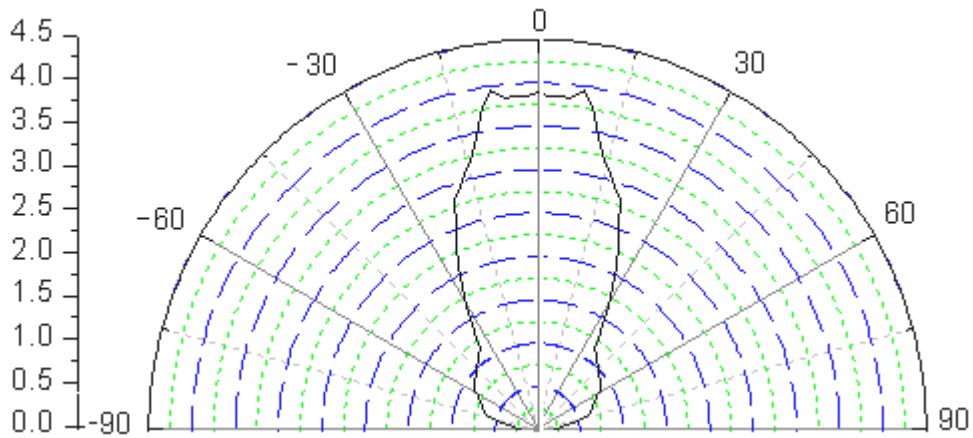


Derating Curve



Typical Radiation Patterns

Typical Diagram Characteristics of Radiation for EAUVA35353



Notes:

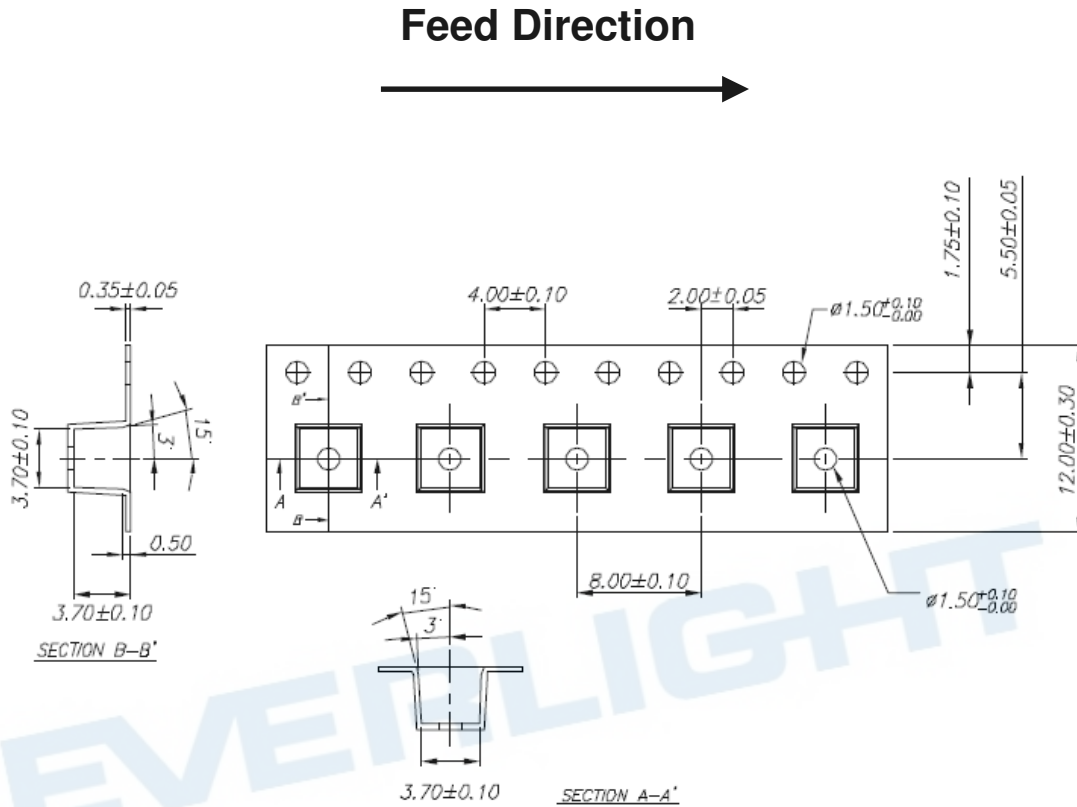
1. $2\theta_{1/2}$ is the off axis angle from lamp centerline where the luminous intensity is 1/2 of the peak value.
2. View angle tolerance is $\pm 5^\circ$.

EVERLIGHT

Emitter Tape Packaging

Carrier Tape Dimensions as the following:

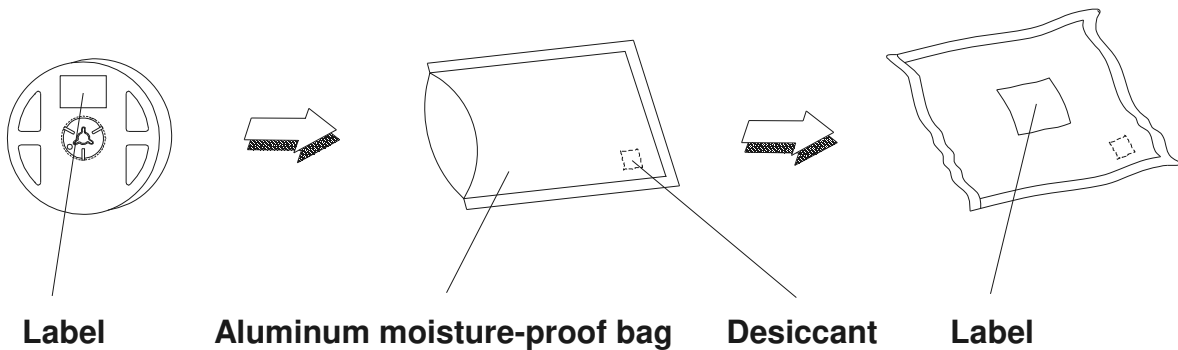
Reel: 400pcs



Notes:

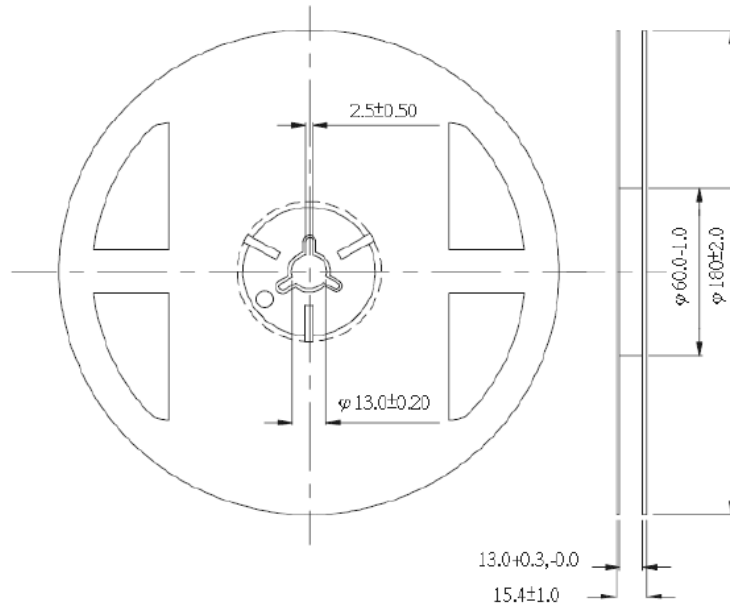
1. Tolerance unless mentioned is ± 0.1 mm; Unit = mm
2. Packing amount is 100/200/300/400 pcs per reel

Moisture Resistant Packaging



Emitter Reel Packaging

Reel Dimensions



Notes:

1. Dimensions are in millimeters.
2. Tolerances unless mentioned are ± 0.1 mm.

Product Labeling

Label Explanation

CPN: Customer Specification (when required)

P/N : Everlight Production Number

QTY: Packing Quantity

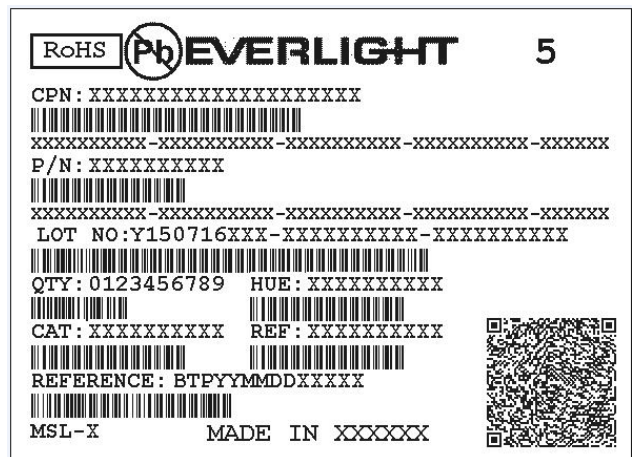
CAT: Luminous Flux (Brightness) Bin

HUE: Color Bin

REF: Forward Voltage Bin

LOT No: Lot Number

MADE IN TAIWAN: Production Place



Storage Conditions

- Before the package is opened. The LEDs should be stored at 30°C or less and 90%RH or less after being shipped from EVERLIGHT and the storage life limits are 12 months.
- After opening the package: The LED's floor life is unlimited under 30°C or less and 85% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: 60±5°C for 24 hours.

DISCLAIMER

- EVERLIGHT reserves the right(s) on the adjustment of product material mix for the specification.
- The product meets EVERLIGHT published specification for a period of twelve (12) months from date of shipment.
- The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
- When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from the use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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